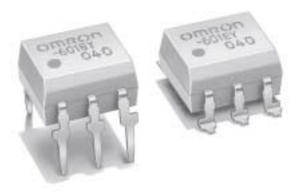


MOS FET Relay

G3VM-601BY/EY

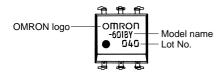
MOS FET Relay for Switching Analog Signals, with an I/O Dielectric Strength of 5 kVAC Using Optical Isolation

- Switches minute analog signals.
- Switches AC and DC.
- Load voltage: 600 V.
- I/O dielectric strength: 5 kVAC.
- UL/CSA approval pending.





■ Appearance



Note: "G3VM" is not printed on the actual product.

Ordering Information

Contact form	Terminals	Load voltage (peak value)	Model	Number per stick	Taping quantity
SPST-NO	PCB terminals		G3VM-601BY	50	
	Surface-mounting terminals	600 VAC	G3VM-601EY	50	
			G3VM-601EY(TR)		1,500

Application Examples

- Electronic automatic exchange systems
- Measuring systems
- FA
- Security systems

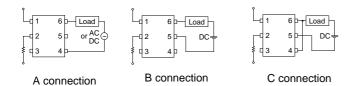
Specifications

■ Absolute Maximum Ratings (Ta = 25°C)

Item			Symbol	Rating	Conditions	
	LED forward current) forward current		50 mA		
Input	LED forward current reduction rate		ΔI _F /°C	-0.5 mA/°C	Ta ≥ 25°C	
	Repetitive peak LED forward current		I _{FP}	1 A	100-µs pulses, 100 pps	
	LED reverse voltage		V_R	5 V		
	Permissible loss		Pin	50 mW		
	Connection temperature		T _J	125°C		
	Output dielectric strength		V_{OFF}	600 V	AC peak value	
	Continuous load cur- rent	A connection		100 mA		
		B connection	Io	100 mA		
		C connection		200 mA		
Output	Peak load current		I _{pead}	0.3 A		
	Output loss		P _{out}	454 mW		
	ON current reduction rate	A connection		−1 mA/°C	Ta ≥ 25°C	
		B connection	ΔI _{ON} /°C	−1 mA/°C		
		C connection		−2 mA/°C		
Total pe	Total permissible loss			504 mW		
Dielectric strength between I/O terminals (See note.)		V_{I-O}	5,000 Vrms	AC, 1 min		
Insulation resistance		R _{I-O}	$5 \times 10^{10} \Omega$	V _S = 500 V, ambient operating humidity ≤ 60%		
Storage temperature			Tstg	−55 to 125°C		
Ambient operating temperature			Та	−40 to 85°C		

Note The dielectric strength between I/O terminals was measured with voltage applied to pins 1, 2, and 3 together, and to pins 4, 5, and 6 together.

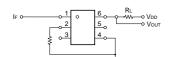
Connection Circuit Diagram



■ Electrical Performance (Ta = 25°C)

ltem		Symbol	Minimum	Standard	Maximum	Conditions	
	LED forward current		V_{F}	1.0 V	1.15 V	1.3 V	I _F = 10 mA
Input Reverse current			I _R			10 μΑ	V _R = 5 V
	Capacity between terminals		C _T		30 pF		V = 0, f = 1 MHz
Output	Maximum resistance with output ON	A connection	R _{ON}		22 Ω	35 Ω	I _{ON} = 100 mA, I _F = 10 mA
		B connection			17 Ω	27 Ω	I _{ON} = 100 mA, I _F = 10 mA
		C connection			8.5 Ω	13.5 Ω	I _{ON} = 200 mA, I _F = 10 mA
	Current leakage when the relay is closed		I _{LEAK}			10 μΑ	V _{OFF} = 600 V
Turn-ON time			T _{ON}		0.5 ms	1.5 ms	$R_L = 200 \Omega$
Turn-OFF time			T _{OFF}		0.1 ms	1.0 ms	(See note.) $V_{DD} = 20 \text{ V},$ $I_F = 5 \text{ mA}$
Floating capacity between I/O terminals			C _{I–O}		0.8 pF		V _S = 0 V, f = 1 MHz

Note The operate and release time were measured in the way shown below.





■ Recommended Operating Conditions

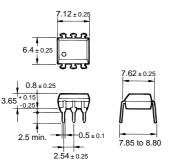
Item	Symbol	Minimum	Standard	Maximum
Operating voltage	V_{DD}			480 V
Forward current	I _F	5 mA		25 mA
Continuous load current	Io			100 mA
Operating temperature	Та	−20°C		65°C

Dimensions

Note All units are in millimeters unless otherwise indicated.

G3VM-601BY

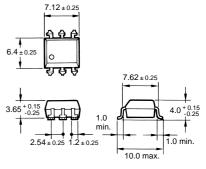




Weight: 0.4 g

G3VM-601EY



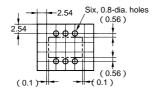


Weight: 0.4 g

Note: "G3VM" is not printed on the actual product.

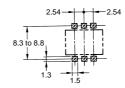
■ PCB Dimensions (Bottom View)

G3VM-601BY



Actual Mounting Pad Dimensions (Recommended Value, Top View)

G3VM-601EY



Installation

■ Terminal Arrangement/Internal Connection (Top View)

G3VM-601BY



G3VM-601EY



Precautions

—! WARNING

Be sure to turn OFF the power when wiring the Relay, otherwise an electric shock may be received.

—! WARNING

Do not touch the charged terminals of the SSR, otherwise an electric shock may be received.

! Caution

Do not apply overvoltage or overcurrent to the I/O circuits of the SSR, otherwise the SSR mya malfunction or burn.

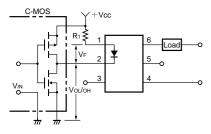
! Caution

Be sure to wire and solder the Relay under the proper soldering conditions, otherwise the Relay in operation may generate excessive heat and the Relay may burn.

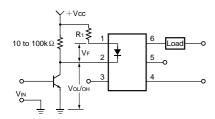
■ Correct Use

Typical Relay Driving Circuit Examples

C-MOS



Transistor



Use the following formula to obtain the LED current limiting resistance value to assure that the relay operates accurately.

$$R_1 = \frac{V_{CC} - V_{OL} - V_F (ON)}{5 \text{ to 20 mA}}$$

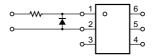
Use the following formula to obtain the LED forward voltage value to assure that the relay releases accurately.

$$V_{F(OFF)} = V_{CC} - V_{OH} < 0.8 \text{ V}$$

Protection from Surge Voltage on the Input Terminals

If any reversed surge voltage is imposed on the input terminals, insert a diode in parallel to the input terminals as shown in the following circuit diagram and do not impose a reversed voltage value of 3 V or more.

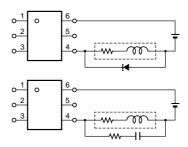
Surge Voltage Protection Circuit Example



Protection from Spike Voltage on the Output Terminals

If a spike voltage exceeding the absolute maximum rated value is generated between the output terminals, insert a C-R snubber or clamping diode in parallel to the load as shown in the following circuit diagram to limit the spike voltage.

Spike Voltage Protection Circuit Example

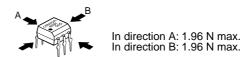


Unused Terminals (6-pin only)

Terminal 3 is connected to the internal circuit. Do not connect anything to terminal 3 externally.

Pin Strength for Automatic Mounting

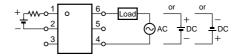
In order to maintain the characteristics of the relay, the force imposed on any pin of the relay for automatic mounting must not exceed the following.



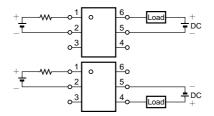
Load Connection

Do not short-circuit the input and output terminals while the relay is operating or the relay may malfunction.

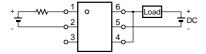
AC Connection



DC Single Connection



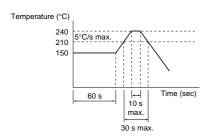
DC Parallel Connection



Solder Mounting

Maintain the following conditions during manual or reflow soldering of the relays in order to prevent the temperature of the relays from rising.

- Pin Soldering Solder each pin at a maximum temperature of 260°C within 10 s.
- 2. Reflow Soldering
 - a. Solder each pin at a maximum temperature of 260°C within 10 s.
 - b. Make sure that the ambient temperature on the surface of the resin casing is 240°C max. for 10 s maximum.
- c. The following temperature changes are recommendable for soldering.



ALL DIMENSIONS SHOWN ARE IN MILLIMETERS.
To convert millimeters into inches, multiply by 0.03937. To convert grams into ounces, multiply by 0.03527.

Cat. No. K114-E1-1 In the interest of product improvement, specifications are subject to change without notice.

OMRON Corporation

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